

MG910M GaAs Hall Element

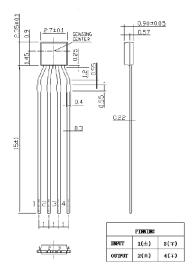
Linear GaAs Hall Element

Excellent Thermal Characteristics

Thin-type SIP Package

Shipped in Bulk by Pack (500pcs devices per pack)

Dimensional Drawing (Unit MM)



Absolute Maximum Rating

Operating Temperature Range -40°C ~ 125°C Storage Temperature Range -45°C ~ 150°C Maximum Input Current I_{cmax} [mA] 13mA

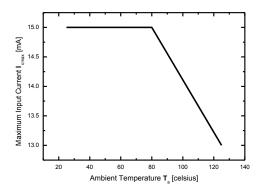


Figure 1. Maximum input current Icmax

Electrical Characteristics (RT=25°C)

Copy Right Reserved JZWI-DS-005 Version 1.0 Matrixopto.Co.,Ltd is the owner of the trademarks used in this document, which has the exclusive right to prevent any third parties not having the owner's consent from using in the course of trade identical or similar signs for

goods or services where such use would result in a likelihood of confusion.



Table I. Electrical Characteristics of MG910M.							
Item	Symbol	Test Condi.	Min.	Тур.	Max.	Unit	
Hall Voltage	V _H	\boldsymbol{B} = 50mT, \boldsymbol{I}_{c} =5mA \boldsymbol{T}_{a} = RT	36	45	54	mV	
Input/Output Resist.	R in/out	$\boldsymbol{B} = \text{OmT}, \boldsymbol{I}_{C} = \text{0.1mA}$ $\boldsymbol{T}_{a} = \text{RT}$	650	750	850	Ω	
Offset Voltage	V os	$\mathbf{B} = 0 \text{mT}, \mathbf{I}_{C} = 5 \text{mA}$ $\mathbf{T}_{a} = \text{RT}$	-5		+5	mV	
Temp. Coeffi. of $V_{\rm H}$	α / _H	$B = 50 \text{mT}, I_C = 5 \text{mA},$ $T_a = 25^{\circ}\text{C} \sim 125^{\circ}\text{C}$			0.06	%/°C	
Temp. Coeffi. of R in	αR_{in}	$B = 0 \text{mT}, I_C = 0.1 \text{mA},$ $T_a = 25^{\circ}\text{C} \sim 125^{\circ}\text{C}$			0.3	%/°C	
Linearity of K	∧ <i>K</i>	B = 0.1 - 0.4T, I _C =5mA	-1		+1	%	

Table 1. Electrical Characteristics of MG910M

Note:

1. $V_{\rm H} = V_{\rm H-M} - V_{\rm os}$

in which $V_{\rm H-M}$ is the Output Hall Voltage, $V_{\rm H}$ is the Hall Voltage and $V_{\rm os}$ is the offset Voltage under the identical electrical stimuli.

 $T_a = RT$

2.
$$\alpha V_{\rm H} = \frac{1}{v_{\rm H} (T_{a1})} \times \frac{v_{\rm H} (T_{a2}) - v_{\rm H} (T_{a1})}{T_{a2} - T_{a1}} \times 100$$

$$T_{a1} = 25$$
°C, $T_{a2} = 125$ °C

3.
$$\alpha R_{\text{in}} = \frac{1}{R_{\text{in}} (T_{a1})} \times \frac{R_{\text{in}}(T_{a2}) - R_{\text{in}} (T_{a1})}{T_{a2} - T_{a1}} \times 100$$

$$T_{a1} = 25$$
°C, $T_{a2} = 125$ °C

4.
$$\Delta K = \frac{K(B_1) - K(B_2)}{\frac{K(B_1) + K(B_2)}{2}} \times 100$$
 $K = \frac{V_H}{I_c \times B}$

Characteristic Curves

Matrixopto.Co.,Ltd is the owner of the trademarks used in this document, which has the exclusive right to prevent any third parties not having the owner's consent from using in the course of trade identical or similar signs for goods or services where such use would result in a likelihood of confusion.



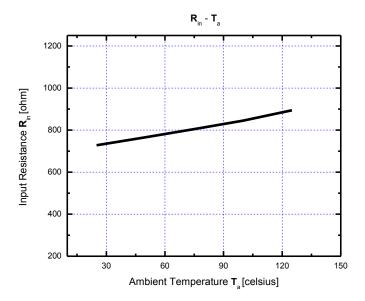


Figure 2.Input resistance R_{in} as a function of ambient temperature T_{a} .

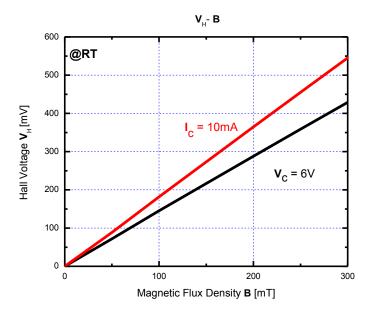


Figure 3. Hall voltage V_H as a function ofmagnetic flux density B.

Copy Right Reserved JZWI-DS-005 Version 1.0 Matrixopto.Co.,Ltd is the owner of the trademarks used in this document, which has the exclusive right to prevent



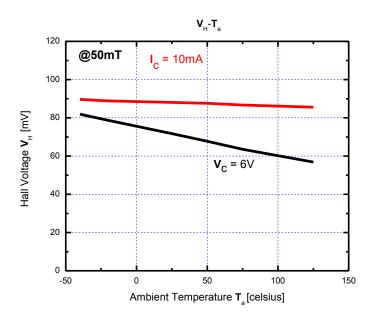


Figure 4. Hall voltage V_H as a function of ambient temperature T_a .

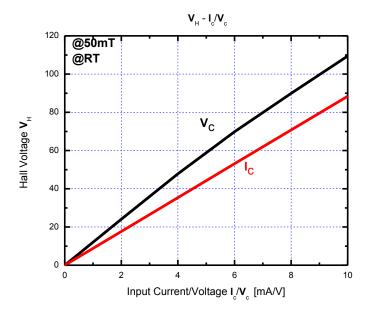


Figure 5. Hall voltage $V_{\rm H}$ as a function of electrical stimuli $I_{\rm c}/V_{\rm c}$.

Reliability Test Terms

Copy Right Reserved

JZWI-DS-005 Version 1.0

Matrixopto.Co.,Ltd is the owner of the trademarks used in this document, which has the exclusive right to prevent



Table 2. Reliability Test Terms, Conditions and Durations.

No.	Terms	Conditions	Duration
1	High Temperature Storage (HTS)	【JEITA EIAJ ED-4701】 7a =150 (0 ~ +10) °C	1000 h
2	Heat Cycle (HC)	[JEITA EIAJ ED-4701] $T_a = -55^{\circ}\text{C} \sim 150^{\circ}\text{C}$ high temp normal temp low temp. $30 \text{ min } -5 \text{ min } -30 \text{ min}$	50 clcs
3	Temp. Humidity Storage (THS)	[JEITA EIAJ ED-4701] $T_a = 85 \pm 3 ^{\circ}\text{C}$, $R_H = 85 \pm 5 ^{\circ}\text{M}$	1000 h
4	Resist. to Hand Soldering Heat (RHSH)	[JEITA EIAJ ED-4701] Dipped in the 300 ± 5 °C solder up to the 1 mm part from the body	5sec
5	High Temp. Operating (HTO)	7 _a =125 °C , V _c =7.5V	1000 h

Criteria:

- Variation of Hall Voltage $\emph{V}_{\rm H}$ and input/output resistances $\emph{R}_{\rm in/out}$ are less than 20%.
- Variation of offset voltage V_{os} is less than ±16 mV.
- Other parameters in **Table 1**. are still within their ranges stated in **Table 1**.

Soldering Conditions

The following conditions should be preserved. Solder ability should be checked by yourself, because it is depend on solder paste material and other parameters.

Material of solder flux

Copy Right Reserved

JZWI-DS-005 Version 1.0

Matrixopto.Co.,Ltd is the owner of the trademarks used in this document, which has the exclusive right to prevent any third parties not having the owner's consent from using in the course of trade identical or similar signs for goods or services where such use would result in a likelihood of confusion.



Matrix Opto. Co., Ltd -MG910M GaAs Hall Element-

- Use the resin based flux and refrain from using organic or inorganic acid based and water-soluble one.

Cleansing of solder flux conditions

- Use Ethanol or Isopropyl alcohol as cleansing material.
- Process temperature should be 50 °C or less.
- Duration should be 5 min or less.

Hand soldering conditions

- Apart from the mold resin more than 1mm.
- Solder at temperature 300 °C for less than 5s.

Wave soldering conditions

- Temperature in Pre-heating zone should be lower than 150°C.
- Temperature in Soldering zone should be lower than 280°C.

Precautions for ESD

This product is the device that is sensitive to ESD (Electrostatic Discharge). Handling Hall Elements with the ESD-Caution mark under the environment in which

- Static electrical charge is unlikely to arise. (Ex; Relative Humidity; over 40%RH).
- Wearing the antistatic suit and wristband when handling the devices.
- Implementing measures against ESD as for containers that directly touch the devices.

Precautions for Storage

Copy Right Reserved JZWI-DS-005 Version 1.0 Matrixopto.Co.,Ltd is the owner of the trademarks used in this document, which has the exclusive right to prevent any third parties not having the owner's consent from using in the course of trade identical or similar signs for goods or services where such use would result in a likelihood of confusion.



Matrix Opto. Co., Ltd -MG910M GaAs Hall Element-

- Products should be stored at an appropriate temperature and humidity (5 to 35°C, 40 to 60%RH) after the unsealing of MBB. **Using self-sealer is highly recommended**. Keeping products away from chlorine and corrosive gas.

- Long-term storage

Products are sealed in MBB with a desiccant and partially a moisture indicator. The moisture indicator should be checked right after the unsealing of MBB. If the moisture indicator reveals the internal moisture is above 50%HR, please contact the local distributor.

- For storage longer than 2 years, it is recommended to store in nitrogen atmosphere with MBB sealed.

Oxygen and H₂O of atmosphere oxidizes leads of products and lead solder ability get worse.

Precautions for Safety

- Do not alter the form of this product into a gas, powder or liquid through burning, crushing or chemical processing.
- Observe laws and company regulations when discarding this product.